



Features

- RoHS compliant*
- Glass passivated chip
- Low reverse leakage current
- Low forward voltage drop
- High current capability

CD214B-F250~F2600 Surface Mount Fast Response Rectifiers

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components. Bourns offers Surface Mount Fast Response Rectifiers for rectification applications, in compact chip DO-214AA (SMB) size format, which offer PCB real estate savings and are considerably smaller than most competitive parts. The Fast Response Rectifier Diodes offer a forward current of 2.0 A with a choice of repetitive peak reverse voltages of 50 V up to 600 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

Electrical Characteristics (@ $T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD214B-						Unit
		F250	F2100	F2150	F2200	F2400	F2600	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	400	600	V
Maximum RMS Voltage	V_{RMS}	35	70	105	140	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	400	600	V
Max. Average Forward Rectified Current ¹	$I_{(AV)}$	2.0						A
DC Reverse Current @ Rated DC Blocking Voltage (@ $T_J = 25\text{ }^{\circ}\text{C}$)	I_R	5.0						μA
DC Reverse Current @ Rated DC Blocking Voltage (@ $T_J = 125\text{ }^{\circ}\text{C}$)	I_R	350						μA
Typical Junction Capacitance ²	C_J	200						pF
Maximum Instantaneous Forward Voltage @ 1 A	V_F	0.92				1.25	1.30	V
Typical Thermal Resistance ³	$R_{\theta JL}$	15						$^{\circ}\text{C/W}$
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50						A

Notes:

1 See Figure 1.

2 Measured @ 1.0 MHz and applied reverse voltage of 4.0 VDC.

3 Thermal resistance from junction to ambient and from junction to lead P.C.B. mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas.

Thermal Characteristics (@ $T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD214B-F250~F2600	Unit
Operating Temperature Range	T_J	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}\text{C}$

*RoHS Directive 2002/95/EC Jan 27, 2003 including Annex.

Specifications are subject to change without notice.

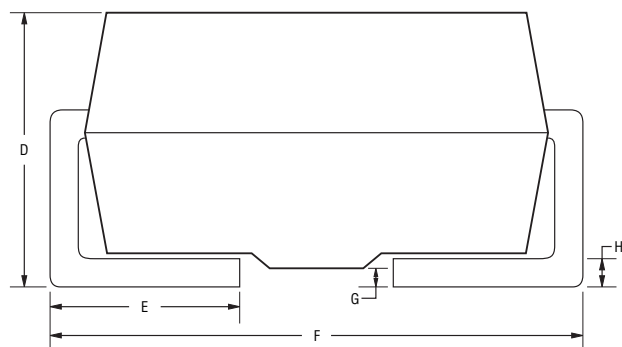
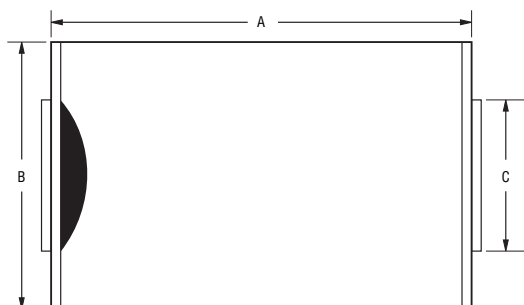
Customers should verify actual device performance in their specific applications.

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Product Dimensions

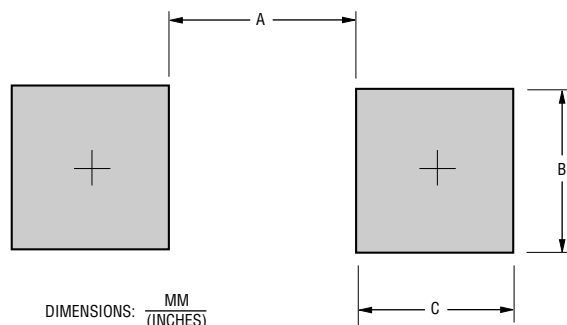
This is an RoHS compliant product. It is a molded plastic package. A cathode band indicates the polarity. The package weighs approximately 0.064 g. The package and dimensions are shown below.



Dimensions	
A	$\frac{4.06 - 4.57}{(0.167 - 0.187)}$
B	$\frac{3.30 - 3.94}{(0.130 - 0.150)}$
C	$\frac{1.96 - 2.21}{(0.075 - 0.087)}$
D	$\frac{2.01 - 2.62}{(0.079 - 0.096)}$
E	$\frac{0.76 - 1.52}{(0.039 - 0.055)}$
F	$\frac{5.21 - 5.59}{(0.197 - 0.236)}$
G	$\frac{0.05 - 0.20}{(0.00196 - 0.00787)}$
H	$\frac{0.15 - 0.31}{(0.006 - 0.016)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Recommended Pad Layout



Dimension	SMB (DO-214AA)
A (Max.)	$\frac{2.69}{(0.106)}$
B (Min.)	$\frac{2.10}{(0.083)}$
C (Min.)	$\frac{1.27}{(0.050)}$

How To Order

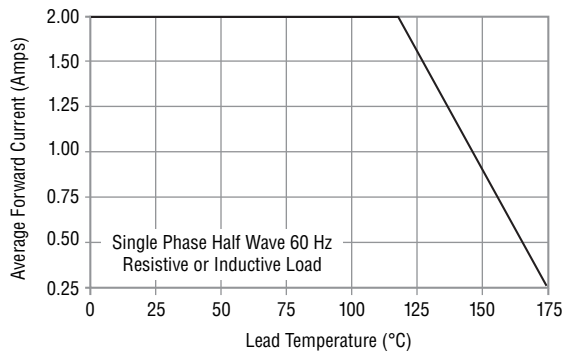
Common Code **CD 214B - F 2 50**
 Chip Diode
 Package
 • 214B = SMB/DO-214AA
 Model
 F = Fast Response Rectifiers
 Forward Current I_{AV}
 2 = 2 A
 Reverse Voltage
 50 = 50 V
 100 = 100 V
 150 = 150 V
 200 = 200 V
 400 = 400 V
 600 = 600 V

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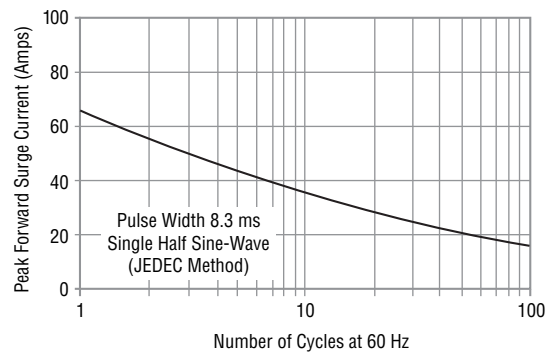
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Rating and Characteristic Curves

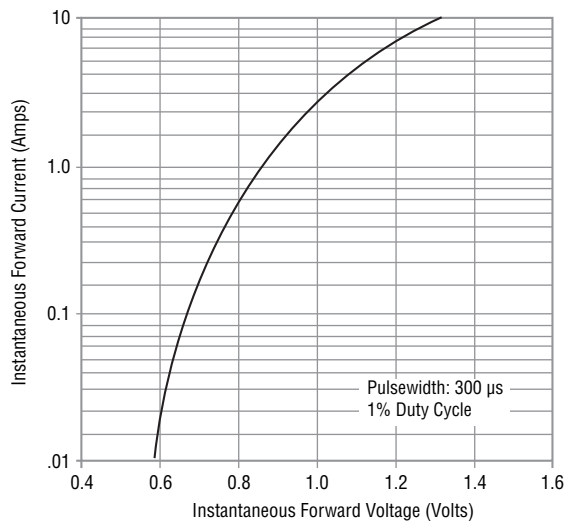
Forward Current Derating Curve



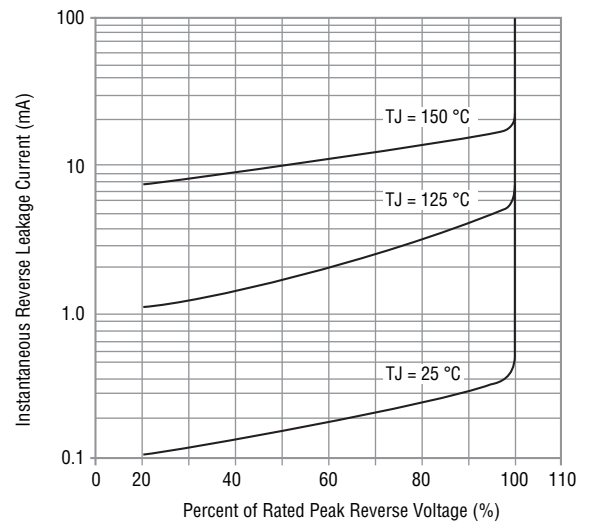
Non-Repetitive Surge Current



Forward Characteristics



Reverse Characteristics

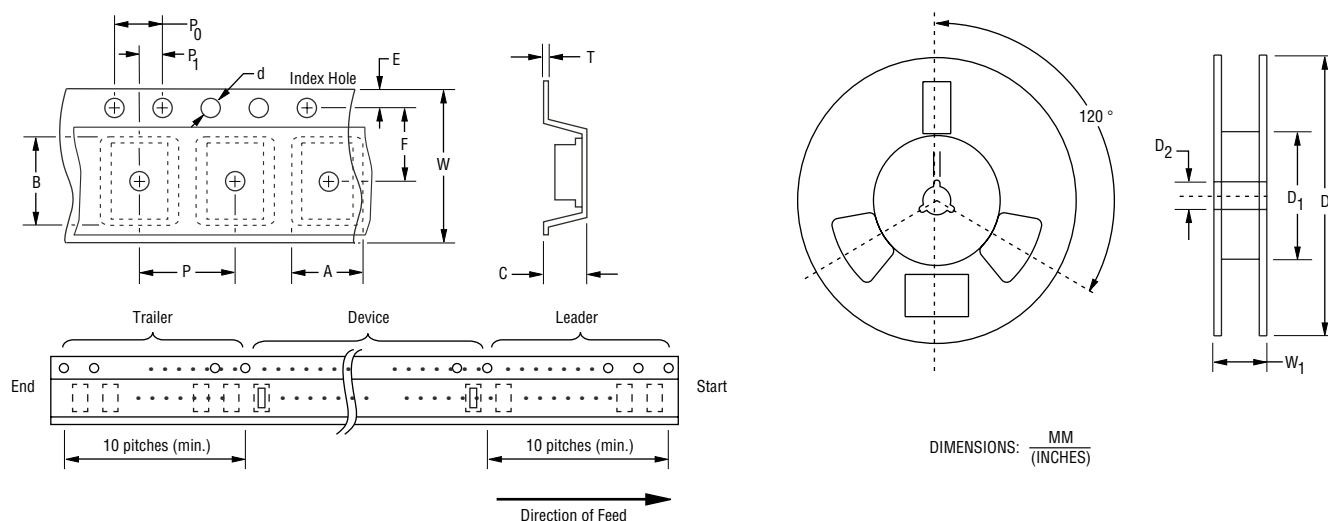


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Packaging Information

The surface mount product is packaged in an 8 mm x 4 mm tape and reel format per EIA-481 standard.



Item	Symbol	DO-214AA (SMB)
Carrier Width	A	$\frac{1.90 \pm 0.10}{(0.075 - 0.004)}$
Carrier Length	B	$\frac{4.30 \pm 0.10}{(0.169 - 0.004)}$
Carrier Depth	C	$\frac{1.80 \pm 0.10}{(0.071 - 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 - 0.002)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D ₁	$\frac{80.0}{(3.150)} \text{ Min.}$
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 - 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 - 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 - 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 - 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 - 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 - 0.008)}$
Reel Width	W ₁	$\frac{13.5}{(0.531)} \text{ Max.}$
Quantity per Reel	—	3,000

REV. 06/11

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